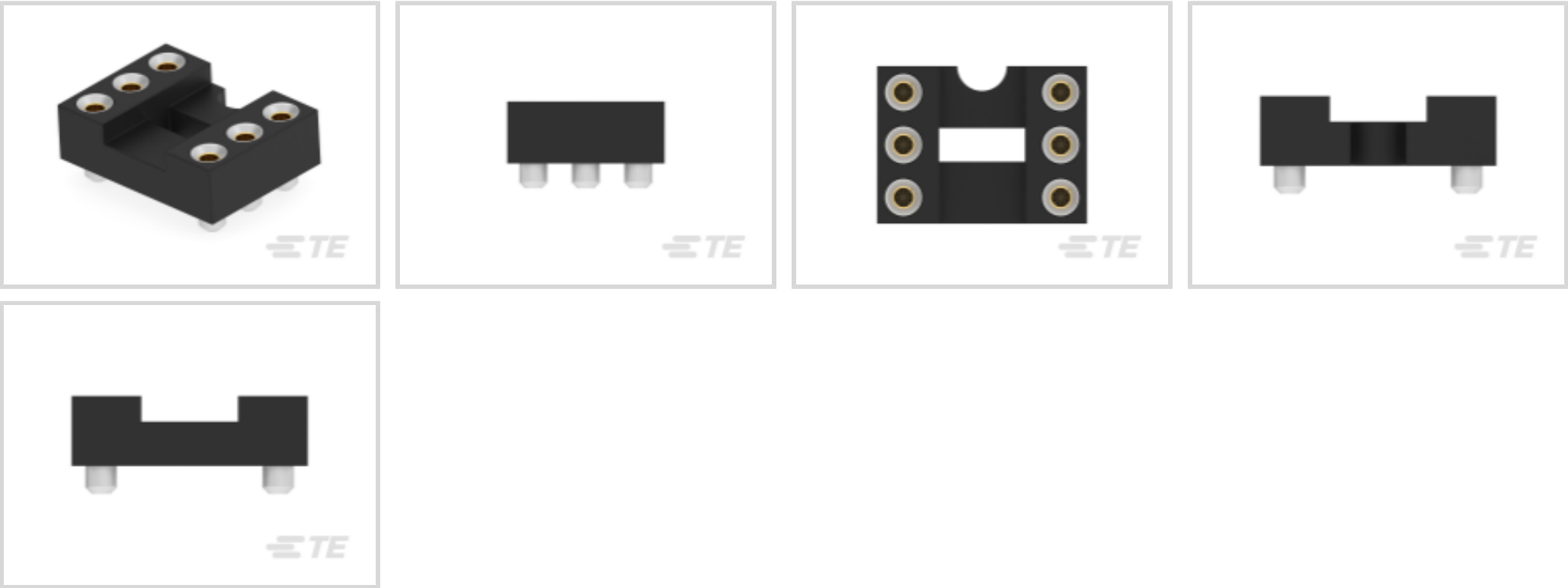




Connectors > Socket Connectors > IC Sockets > DIP Sockets



Contact Fabrication: Solid

Number of Positions: 6

Row-to-Row Spacing: 7.62 mm [.3 in]

Leg Style: SMD Pads

Contact Mating Area Plating Material: Gold Flash

Features

Product Type Features

Leg Style	SMD Pads
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Configuration Features

Number of Positions	6
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Contact Features

Contact Fabrication	Solid
Contact Mating Area Plating Material	Gold Flash
Contact Current Rating (Max)	1 A

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]
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Dimensions

Row-to-Row Spacing	7.62 mm[.3 in]
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Usage Conditions

Operating Temperature Range	-55 – 125 °C[-55 – 125 °F]
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE’s information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) ‘Guidance on requirements for substances in articles’(Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of ‘complex object’, the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA “Guidance on requirements for substances in articles” (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts



TE Part # 2485267-3
DIP IC SOCKET 10P,GOLD FLASH-SMD



TE Part # 2485267-2
DIP IC SOCKET 8P,GOLD FLASH-SMD



TE Part # 2485267-4
DIP IC SOCKET 12P,GOLD FLASH-SMD

Documents

Product Drawings
DIP IC SOCKET 6P,GOLD FLASH-SMD
English



CAD Files

Customer View Model

[ENG_CVM_CVM_2485267-1_1.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2485267-1_1.3d_stp.zip](#)

English

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_2485267-1_1.2d_dxf.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Product Specification

English